

AGENDA
 K-16 COMMITTEE ON HEAT TRANSFER IN ELECTRONIC EQUIPMENT
 2009 ASME IMECE
 WDW Swan and Dolphin Hotel, Lake Buena Vista, FL, USA
 Tuesday, Nov. 17, 5:30-7:00pm

Other meetings/events which may be of interest:

Meeting	Day	Date	Start Time	End Time	Room
HTD Exec Committee Mtg (open)	Sunday	11/15/2009	4:30 PM	5:30 PM	TBD
InterPACK 2011 Planning	Tuesday	11/17/2009	7:30pm	8:00pm	TBD
ITherm 2010 Planning	Tuesday	11/17/2009	8:00pm	9:00pm	TBD
Electronic and Photonic Packaging Division Wine and Cheese Reception	Wednesday	11/18/2009	6:30 PM	8:00 PM	TBD
Electronic and Photonic Packaging Division General Meeting	Wednesday	11/18/2009	8:00 PM	9:00 PM	TBD

1. Self-introduction of attending K-16 committee members (5:30-5:35)
2. Approval of minutes of K-16 meeting from 009 InterPACK Conference, San Francisco (posted on K-16 Website) and report on K-16 Web Site (5:50-5:55) Sam Graham
3. Heat Transfer Division Report (5:35-5:50)
4. Report on 2009 IMECE (5:55-6:05)
Pradip Majumdar, 2009 IMECE KCR
5. Update, ITherm 2010 , June 2-5, 2010, Las Vegas. (6:05-6:15)
Yogi Joshi, Conference Chair
6. Update, 14th International Heat Transfer Conference (IHTC), Washington D.C., August 8-13, 2010. (6:15-6:25)
Avi Bar-Cohen, Conference Chair
7. Update, 2011 Heat Transfer Division 2011 ASME/JSME AJTEC Conference, March 13-17, 2011, Honolulu, HI
Seri Lee (6:25-6:35)
8. Report on Journal of Electronic Packaging (6:35-6:45)
Bahgat Sammakia (Binghamton University), Editor
9. NEW BUSINESS
 - a. IMECE 2010 Denver : selection/nomination of KCR (6:45-6:55)
 - b. K-16 clock award selection for 2010 will be chaired by Michael Ellsworth . Presentation will be at the EPPD wine and cheese reception at IMECE 2010 in Denver. (6:55-7:00)
10. Next K-16 Committee Meeting: 2010 ITherm, June 2-5, 2010, Las Vegas. (7:00)
11. Meeting Adjournment (7:00)